STF5N65M6



N-channel 650 V, 1.15 Ω typ., 4 A MDmesh™ M6 Power MOSFET in a TO-220FP package

Datasheet - production data

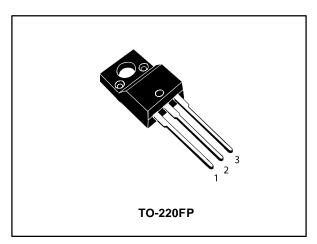
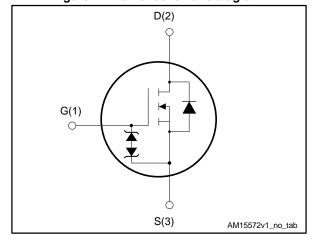


Figure 1: Internal schematic diagram



Features

Order code	V _{DS}	R _{DS(on)} max.	ΙD
STF5N65M6	650 V	1.3 Ω	4 A

- Reduced switching losses
- Lower R_{DS(on)} x area vs previous generation
- Low gate input resistance
- 100% avalanche tested
- Zener-protected

Applications

• Switching applications

Description

The new MDmeshTM M6 technology incorporates the most recent advancements to the well-known and consolidated MDmesh family of SJ MOSFETs. STMicroelectronics builds on the previous generation of MDmesh devices through its new M6 technology, which combines excellent $R_{DS(on)}$ * area improvement with one of the most effective switching behaviors available, as well as a user-friendly experience for maximum endapplication efficiency.

Table 1: Device summary

Order code	Marking	Package	Packing
STF5N65M6	5N65M6	TO-220FP	Tube

Contents STF5N65M6

Contents

1	Electric	al ratings	3
2	Electric	cal characteristics	4
	2.1	Electrical characteristics (curves)	6
3	Test cir	·cuits	8
4	Packag	e information	9
	4.1	TO-220FP package information	10
5	Revisio	n history	12

STF5N65M6 Electrical ratings

1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _G s	Gate-source voltage	± 25	V
I _D	Drain current (continuous) at T _C = 25 °C	4	Α
ΙD	Drain current (continuous) at T _C = 100 °C	2.5	Α
I _{DM} ⁽¹⁾	Drain current (pulsed)	16	Α
P _{TOT}	Total dissipation at T _C = 25 °C	20	W
dv/dt ⁽²⁾	Peak diode recovery voltage slope	5	V/ns
dv/dt ⁽³⁾	MOSFET dv/dt ruggedness	50	V/IIS
V _{ISO}	Insulation withstand voltage (RMS) from all three leads to external heat sink (t = 1 s, T_C = 25 °C)	2.5	kV
TJ	Operating junction temperature range	FF to 150	°C
T _{stg}	Storage temperature range	-55 to 150	

Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case	6.25	°C/W
R _{thj-amb}	Thermal resistance junction-ambient	62.5	*C/VV

Table 4: Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AR}	Avalanche current, repetitive or not repetitive (pulse width limited by T _{jmax})	1	Α
Eas	Single pulse avalanche energy (starting T_j =25°C, I_D = I_{AR} , V_{DD} =50 V)	90	mJ

⁽¹⁾Pulse width limited by safe operating area

 $^{^{(2)}}I_{SD} \leq 4$ A, di/dt = 400 A/ μ s; VDS peak < V(BR)DSS, VDD = 400 V

 $^{^{(3)}}V_{DS} \le 520 \text{ V}$

Electrical characteristics STF5N65M6

2 Electrical characteristics

T_C = 25 °C unless otherwise specified

Table 5: On/off-state

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$V_{GS}=0$, $I_D=1$ mA	650			V
		V _{GS} = 0 V, V _{DS} = 650 V			1	μΑ
I _{DSS}	Zero gate voltage drain current	$V_{GS} = 0 \text{ V}, V_{DS} = 650 \text{ V};$ $T_{C} = 125 \text{ °C}^{(1)}$			100	μΑ
Igss	Gate body leakage current	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 25 \text{ V}$			±5	μΑ
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	2.25	3	3.75	V
R _{DS(on)}	Static drain-source on-resistance	$V_{GS} = 10 \text{ V}, I_D = 2 \text{ A}$		1.15	1.3	Ω

Notes:

Table 6: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	170	•	pF
Coss	Output capacitance	V _{DS} = 100 V, f = 1 MHz, V _{GS} = 0 V	-	20	ı	pF
C _{rss}	Reverse transfer capacitance	755 = 166 V, 1 = 1 Mile, V66 = 6 V	-	1	ı	pF
Coss	Equivalent output capacitance	V _{DS} = 0 to 520 V, V _{GS} = 0 V	-	35	-	pF
Rg	Intrinsic gate resistance	f = 1 MHz, I _D =0 A	1	5	ı	Ω
Qg	Total gate charge	V _{DD} = 350 V, I _D = 1 A, V _{GS} = 10 V,	-	5.1	•	nC
Qgs	Gate-source charge	(see Figure 15: "Test circuit for	-	8.0	ı	nC
Q_{gd}	Gate-drain charge	gate charge behavior")	-	2	1	nC

Notes:

Table 7: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	V_{DD} = 325 V, I_D = 2 A, R_G = 4.7 Ω ,	ı	6.5	-	ns
t _r	Rise time	V _{GS} = 10 V (see Figure 14: "Test circuit for resistive load switching	-	5.9	-	ns
t _{d(off)}	Turn-off delay time	times" and Figure 19: "Switching	-	17.4	-	ns
t _f	Fall time	time waveform")	-	15.2	-	ns

 $^{^{(1)}}$ Defined by design, not subject to production test.

 $^{^{(1)}}C_{oss\ eq.}$ is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS}

Table 8: Source-drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Isp	Source-drain current		-		4	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)				16	Α
V _{SD} ⁽²⁾	Forward on voltage	I _{SD} = 4 A, V _{GS} = 0 V	-		1.6	V
t _{rr}	Reverse recovery time	I _{SD} = 4 A, di/dt = 100 A/µs,	-	222		ns
Qrr	Reverse recovery charge	V _{DD} = 60 V, (see <i>Figure 19</i> :	-	1.24		μC
I _{RRM}	Reverse recovery current	"Switching time waveform")	-	11.2		Α
t _{rr}	Reverse recovery time	I _{SD} = 4 A, di/dt = 100 A/μs,	-	264		ns
Qrr	Reverse recovery charge	$V_{DD} = 60 \text{ V}, T_j = 150 \text{ °C}$ (see Figure 19: "Switching"	-	1.39		μC
I _{RRM}	Reverse recovery current	time waveform")	-	10.5		Α

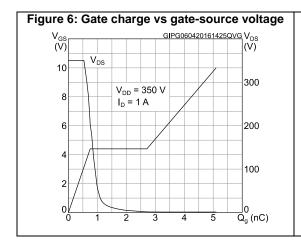
Notes:

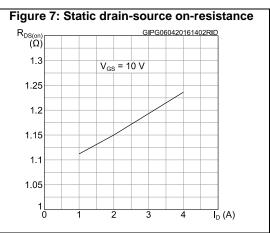
⁽¹⁾Pulse width limited by safe operating area

 $^{^{(2)}}$ Pulsed: pulse duration = 300 μ s, duty cycle 1.5%

2.1 Electrical characteristics (curves)

Figure 2: Safe operating area GIPG060420161432SOA (A) Operation in this area is limited by R_{DS(on)} 10 t_⊳=10 µs 10⁰ t₀=100 µs t =1 ms t_o=10 ms 10 T_j≤150 °C T_o= 25°C single pulse 10⁻² $\bar{V}_{DS}(V)$ 10¹ 10²





STF5N65M6 Electrical characteristics

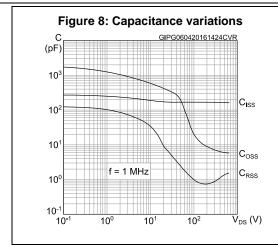


Figure 10: Normalized on-resistance vs temperature

R_{DS(on)} GIPG060420161401RON

2.2 V_{GS} = 10 V

1.8

1.4

1.0

0.6

0.2

-75

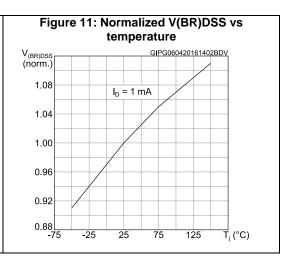
-25

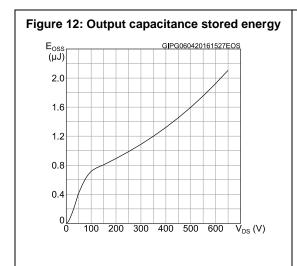
25

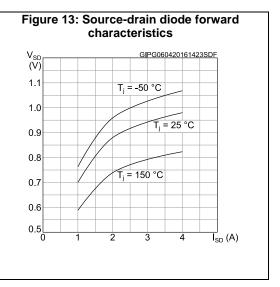
75

125

T_j (°C)







Test circuits STF5N65M6

3 Test circuits

Figure 14: Test circuit for resistive load switching times

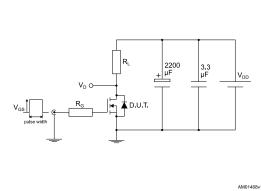


Figure 16: Test circuit for inductive load switching and diode recovery times

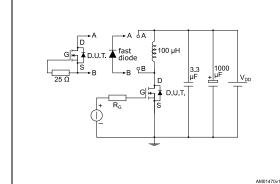


Figure 17: Unclamped inductive load test circuit

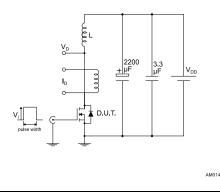


Figure 18: Unclamped inductive waveform

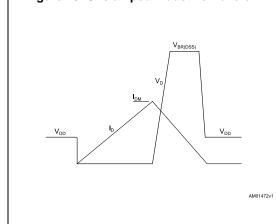
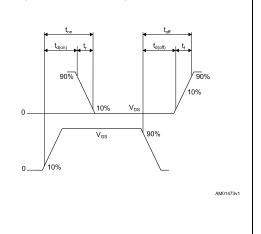


Figure 19: Switching time waveform



STF5N65M6 Package information

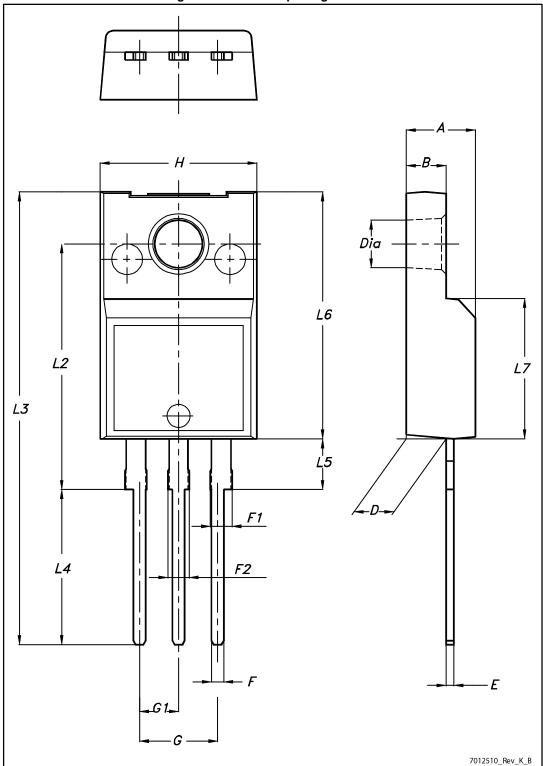
4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.



4.1 TO-220FP package information

Figure 20: TO-220FP package outline



STF5N65M6

Table 9: TO-220FP package mechanical data

Dim		mm	
Dim.	Min.	Тур.	Max.
A	4.4		4.6
В	2.5		2.7
D	2.5		2.75
Е	0.45		0.7
F	0.75		1
F1	1.15		1.70
F2	1.15		1.70
G	4.95		5.2
G1	2.4		2.7
Н	10		10.4
L2		16	
L3	28.6		30.6
L4	9.8		10.6
L5	2.9		3.6
L6	15.9		16.4
L7	9		9.3
Dia	3		3.2

Revision history STF5N65M6

5 Revision history

Table 10: Document revision history

Date	Revision	Changes
05-May-2016	1	Initial release.

IMPORTANT NOTICE - PLEASE READ CAREFULLY

STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST's terms and conditions of sale in place at the time of order acknowledgement.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of Purchasers' products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2016 STMicroelectronics - All rights reserved

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for MOSFET category:

Click to view products by STMicroelectronics manufacturer:

Other Similar products are found below:

614233C 648584F IRFD120 JANTX2N5237 FCA20N60_F109 FDZ595PZ 2SK2545(Q,T) 405094E 423220D TPCC8103,L1Q(CM MIC4420CM-TR VN1206L SBVS138LT1G 614234A 715780A NTNS3166NZT5G SSM6J414TU,LF(T 751625C BUK954R8-60E NTE6400 SQJ402EP-T1-GE3 2SK2614(TE16L1,Q) 2N7002KW-FAI DMN1017UCP3-7 EFC2J004NUZTDG ECH8691-TL-W FCAB21350L1 P85W28HP2F-7071 DMN1053UCP4-7 NTE221 NTE2384 NTE2903 NTE2941 NTE2945 NTE2946 NTE2960 NTE2967 NTE2969 NTE2976 NTE455 NTE6400A NTE2910 NTE2916 NTE2956 NTE2911 DMN2080UCB4-7 TK10A80W,S4X(S SSM6P69NU,LF DMP22D4UFO-7B DMN1006UCA6-7